# FAIRCHILD SEMICONDUCTOR®

# FDD6685

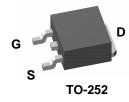
# 30V P-Channel PowerTrench<sup>o</sup> MOSFET

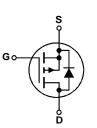
### **General Description**

This P-Channel MOSFET is a rugged gate version of Fairchild Semiconductor's advanced PowerTrench process. It has been optimized for power management applications requiring a wide range of gave drive voltage ratings (4.5V – 25V).

## Features

- -40 A, -30 V.  $R_{DS(ON)} = 20 \text{ m}\Omega @ V_{GS} = -10 \text{ V}$  $R_{DS(ON)} = 30 \text{ m}\Omega @ V_{GS} = -4.5 \text{ V}$
- Fast switching speed
- High performance trench technology for extremely low  $R_{\text{DS}(\text{ON})}$
- High power and current handling capability
- Qualified to AEC Q101





## Absolute Maximum Ratings TA=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units	
V <sub>DSS</sub>	Drain-Source Voltage		-30	V	
V <sub>GSS</sub>	Gate-Source Voltage		±25	V	
I <sub>D</sub>	Continuous Drain Current @Tc=25°C	(Note 3)	-40		
	@T <sub>A</sub> =25°C	(Note 1a)	-11	A	
	Pulsed, PW ≤ 100	<b>)µS</b> (Note 1b)	-100		
PD	Power Dissipation for Single Operation	(Note 1)	52	W	
		(Note 1a)	3.8		
		(Note 1b)	1.6		
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperation	ure Range	-55 to +175	°C	

# **Thermal Characteristics**

$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	(Note 1)	2.9	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	40	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1b)	96	°C/W

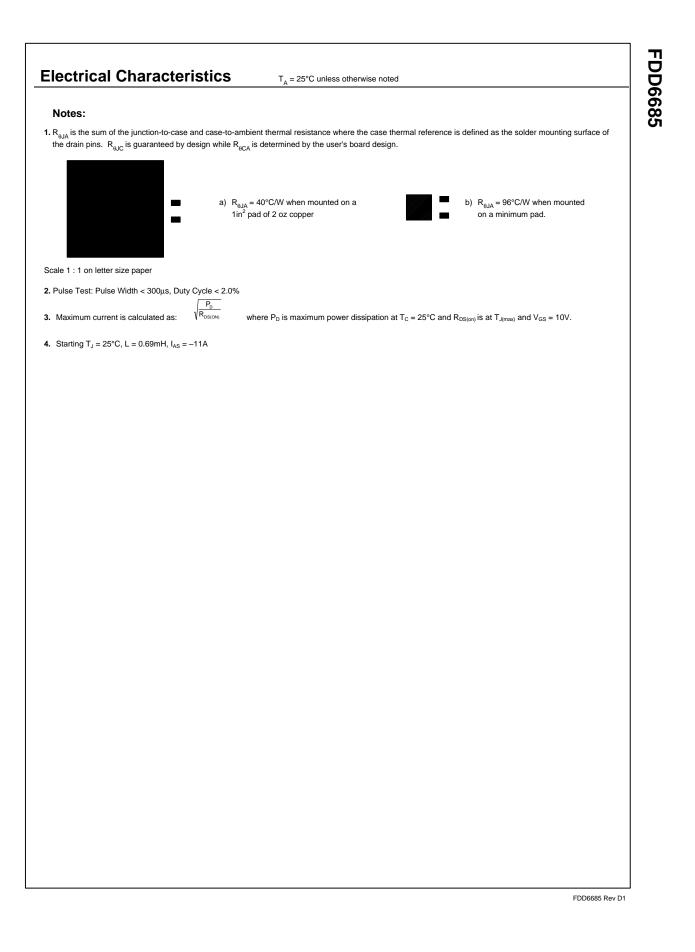
This product has been designed to meet the extreme test conditions and environment demanded by the automotive industry. For a copy of the requirements, see AEC Q101 at http://www.aecouncil.com/

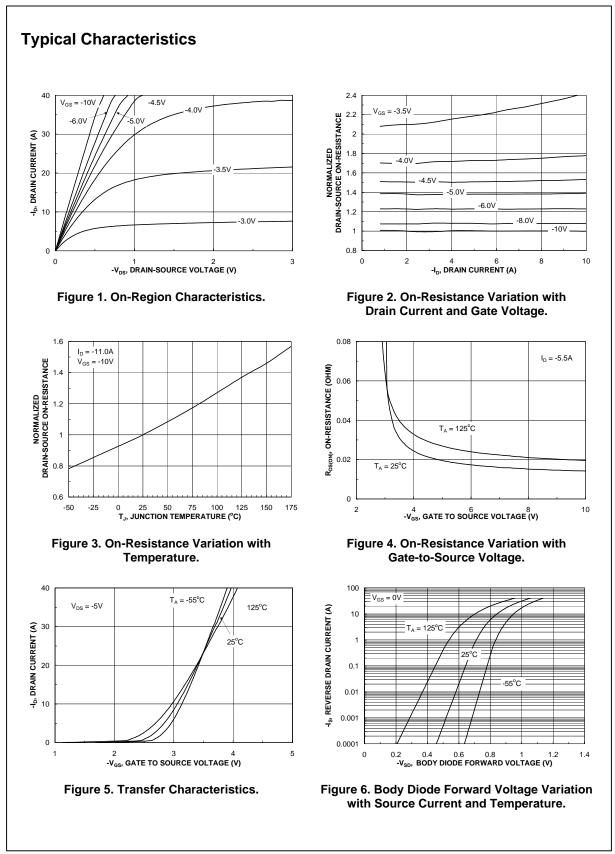
Reliability data can be found at: http://www.fairchildsemi.com/products/discrete/reliability/index.html. All Fairchild Semiconductor products are manufactured, assembled and tested under ISO9000 and QS9000 quality systems certification.

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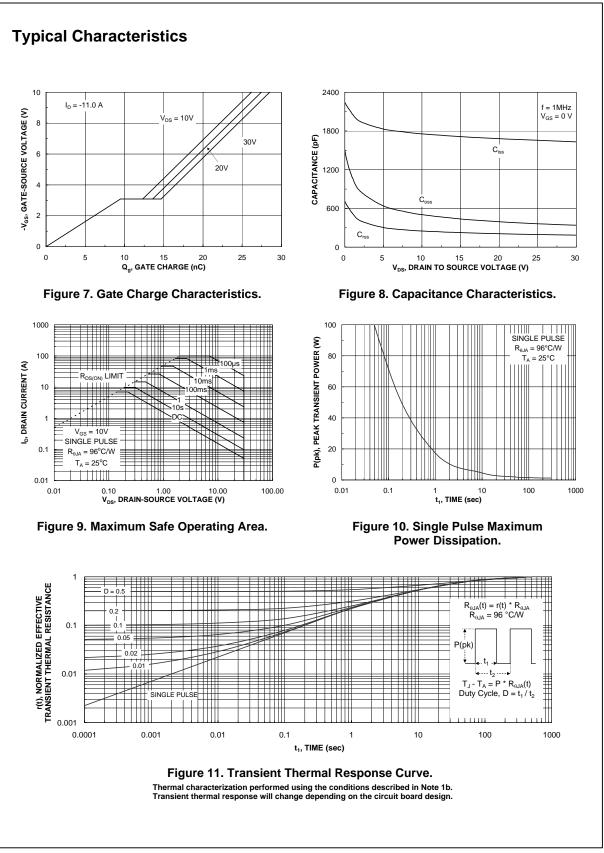
Device Marking Device		Reel Size Tape Wi		dth Quantity				
FDD	FDD6685 FDD6685		13" 12mn		n 2500 units			nits
Electric	al Char	acteristics	T <sub>A</sub> = 25°C unless otherwise	noted				
Symbol		Parameter	Test Conditions		Min	Тур	Max	Units
Drain-So	urce Ava	lanche Ratings (Note	: 4)					
AS		se Drain-Source	$I_{\rm D} = -11  {\rm A}$			42		mJ
AS	Maximum Avalanche	Drain-Source Current				-11		A
Off Chara	acteristic	S						
3V <sub>DSS</sub>	Drain-Sou	rce Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_{D} = -250 \text{ J}$	ιA	-30			V
<u>ΔBVdss</u> ΔTj	Breakdown Coefficient	n Voltage Temperature	$I_D = -250 \ \mu A$ , Referenced to $25^{\circ}C$			-24		mV/°C
DSS	Zero Gate	Voltage Drain Current	$V_{\text{DS}} = -24 \text{ V},  V_{\text{GS}} =$				-1	μA
GSS	Gate-Bod	y Leakage	$V_{GS} = \pm 25V,  V_{DS} = 0 V$				±100	nA
On Chara	acteristic	S (Note 2)						
V <sub>GS(th)</sub>	Gate Three	shold Voltage	$V_{DS}=V_{GS},\ I_D=-250$	μA	-1	-1.8	-3	V
ΔV <sub>GS(th)</sub> ΔT <sub>J</sub>		shold Voltage ire Coefficient	$I_D$ = -250 $\mu$ A, Referenced to 25°C			5		mV/°C
R <sub>DS(on)</sub>	Static Drai On–Resist		$ \begin{array}{l} V_{GS} = -10 \ V, \qquad I_D = -11 \ A \\ V_{GS} = -4.5 \ V, \qquad I_D = -9 \ A \\ V_{GS} = -10 \ V, I_D = -11 \ A, T_J = 125^\circ C \end{array} $			14 21 20	20 30	mΩ
D(on)	On-State	Drain Current	$V_{GS} = -10 \text{ V}, \qquad V_{DS} = -5 \text{ V}$		-20			А
JFS	Forward T	ransconductance	$V_{\text{DS}} = -5 \ \text{V}, \qquad \  \  I_{\text{D}} =$	–11 A		26		S
Dynamic	Characte	eristics						
Ciss	Input Capa		$V_{DS} = -15 V$ , $V_{GS}$	= 0 V,		1715		pF
Coss	Output Ca	pacitance	f = 1.0 MHz			440		pF
Crss	Reverse T	ransfer Capacitance				225		pF
R <sub>G</sub>	Gate Resis	stance	$V_{GS} = 15 \text{ mV},  f = 1.0 \text{ MHz}$			3.6		Ω
Switchin	a Charac	teristics (Note 2)						
d(on)	Turn–On E	· · ·				17	31	ns
Г	Turn–On F	Rise Time				11	21	ns
d(off)	Turn–Off D	Delay Time				43	68	ns
f	Turn–Off F	all Time	-			21	34	ns
Qg	Total Gate	Charge				17	24	nC
Q <sub>gs</sub>	Gate-Sou	rce Charge				9		nC
$\mathcal{Q}_{gd}$	Gate-Drai	n Charge			4		nC	
Drain-So	ource Dio	de Characteristics	and Maximum Ra	atings				
V <sub>SD</sub>		rce Diode Forward	$V_{GS} = 0 V, I_{S} = -3.2$			-0.8	-1.2	V
Trr	Diode Rev	erse Recovery Time	IF = -11 A,			26		ns
Qrr	Diode Rev	erse Recovery Charge	diF/dt = 100 A/µs			13		nC





FDD6685

FDD6685 Rev D1



FDD6685

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